LNJ818C83RA

Hight Bright Surface Mounting Chip LED

Dome-Lens Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	55	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Lighting Color

Ambient temperature Ta (°C)

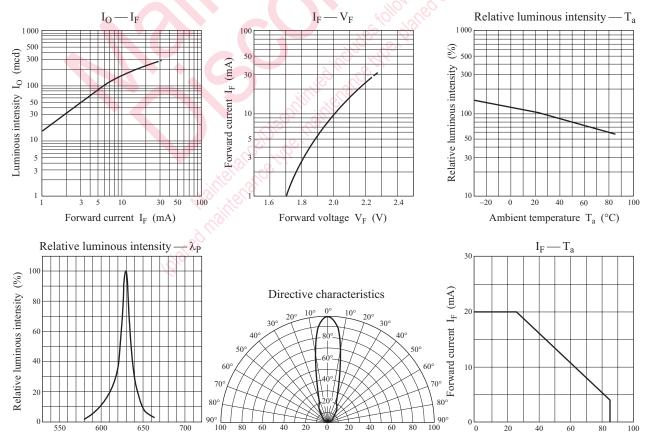
Orange

■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

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Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_F = 10 \text{ mA}$	85	160	·0,	mcd
Reverse current	I_R	$V_R = 4 V$	111	50,0	10	μΑ
Forward voltage	V_{F}	$I_F = 10 \text{ mA}$	9110	2.03	2.5	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	in the	630		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	OLILI	15		nm

Note) *: Measurement tolerance: ±20%

Peak emission wavelength λ_P (nm)

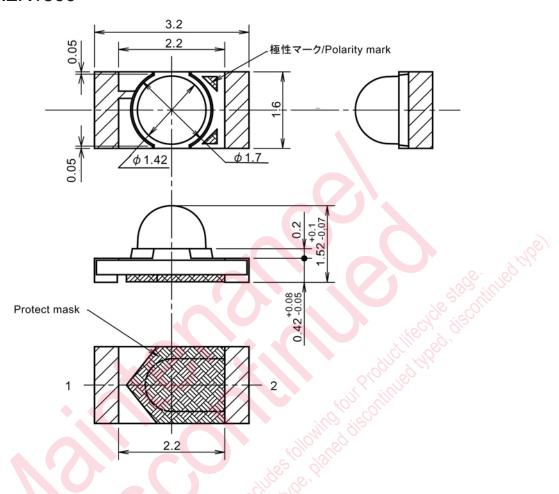


Relative luminous intensity (%)

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■ Package (Unit: mm)

KLTLTN2K1800



- Pin name
 - 1: Anode
 - 2: Cathode

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